		nt/Grantee	Microchip Technol					
FC	C ID	:	2ADHKWFI32E02					
Section 15.212 Modular Transmitters /								
X	Reg	uest for Moa	Requirements	Kequ	Device Conditions	Comply (Y/N)		
			<u> </u>	Andular /	Approval Requirements	Comply (1/N)		
	1	The radio elements must have the radio frequency circuitry must be shielded. Physical/discrete and tuning capacitors may be located external to the shield, but must be on the module assembly.			The module has its own RF shielding." Shield Can is employed on the board structure, please see exhibition External Photo, the emission measurement was conducted without further shielding added.	Y		
	2	modulation/da provided) to e comply with t applicable RS	hall have buffered ata input(s) (if such it insure that the modulate he requirements set S standard under contact ata rates or over-modulate	le will out in the nditions	inputs, it is integrated on the RF chip	Υ		
	3	supply regulatensure that the the requiremental standard regarence which Requirements standard regarence design of the part of	hall have its own portion on the module. The module will complete module will complete the set out in the appropriate of the design of the design of the design of the module. The set out in the application of the power supplying circle which houses the results of the power supplying circle which have the results of the power supplying circle which have the results of the results	This is to y with blicable of the ost able cuitry in	Output power is controlled by the RF Chip and de-coupled from supply voltage variations. Frequencies are determined by Crystal	Y		
	4	provisions for and antennas Equipment ce contain a deta	hall comply with the external power ampedetailed in this stand rtification submissional iled description of the of all antennas that module.	olifiers lard. The on shall ne	The antenna is part of the module	Υ		
:	5	with the applications configuration	hall be tested for corcable standard in a sration, i.e. the modulanother device durin	tand- le must	The modular transmitter was tested in a stand-alone configuration via a UART Interface.	Υ		
	6		hall comply with the uipment labelling	<b>,</b>	In the exhibition OEM manual, there are Instructions given to the OEM on how to label the end product.	Y		

7	The modular transmitter complies with all specific rules or operating requirements that ordinarily apply to a complete transmitter and the manufacturer will provide adequate instructions along with the module to explain any such requirements. A copy of these instructions is included in this application for equipment authorization:	Instructions in User Manual	Υ
8a	Address compliance with the Commission's RF exposure limits in Sections 1.1310 and 2.1093. In addition, spread spectrum transmitters operating under Section 15.247 are required to address RF exposure compliance in accordance with Section 15.247(b)(4).	Please refer the Maximum Permissible Exposure Information.	Y

A **limited modular approval** may be granted for single or split modular transmitters that do not comply with all of the above requirements, *e.g.*, shielding, minimum signaling amplitude, buffered modulation/data inputs, or power supply regulation, if the manufacturer can demonstrate by alternative means in the application for equipment authorization that the modular transmitter meets all the applicable Part 15 requirements under the operating conditions in which the transmitter will be used. Limited modular approval also may be granted in those instances where compliance with RF exposure rules is demonstrated only for particular product configurations. The applicant for certification must state how control of the end product into which the module will be installed will be maintained such that full compliance of the end product is always ensured.

## **Signature**

Name/Title: HRUSHIKESH VASUKI / Director, Business Unit General Manager, WSG

Company Name: Microchip Technology Inc.

Date: 05.25.2023